

Epitaxial growth of highly strained RuO₂ thin film by self-buffering method

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Rutile RuO₂ draws considerable attention for its applications in the field of electronics and chemical industry because of its rare combination of low resistivity (35 $\mu\Omega$ cm) at room temperature and high thermal and chemical stability [1]. In applications for electrodes and catalysts, RuO₂ is often deposited as thin films onto surfaces of active materials, and is subjected to external stress caused by growth mode of crystal and/or lattice mismatch [2]. Despite the possibly great impact on electrical and electrochemical properties, strain effect in RuO₂ has been scarcely explored partly because of the lack of method to control strain in rutile RuO₂, whose lattice constants hardly match to those of available single crystal substrates. Although surface-growth-mode-induced strain is a good candidate to apply external strain to a film, the strain amplitude is limited to about 1% at highest. In this study, we report successful growth of highly strained RuO₂ epitaxial thin films with self-buffering method and its physical properties.

Rutile RuO₂ epitaxial thin films were deposited on yttria-stabilized zirconia (YSZ) (111) and sapphire (0001) substrates by pulsed laser deposition. In the self-buffering method, buffer layer was deposited at 450°C followed by the deposition of main layer at various temperatures in order to control strain state. X-ray diffraction showed epitaxial growth of (100)-oriented RuO₂ with three-fold multi domain structure. Reciprocal space mapping clearly evidenced the highest strain of 3.4% and 4.0% in RuO₂ thin films on YSZ (111) and sapphire (0001) substrates, respectively, at the optimum growth temperature (Fig. 1). Island growth mode observed by atomic force microscope suggests that surface-growth-mode-induced strain was enhanced by the buffer layer (Fig. 2.).

[1] G.V. Samsonov, *The Oxide Handbook*, (IFI/Plenum, New York, 1982). [2] W. D. Nix *et al.*, *J. Mater. Res.*, **14**, 3467 (1999).

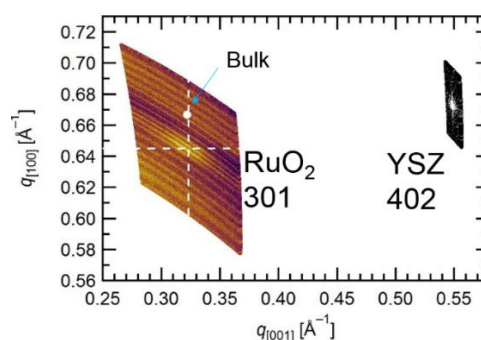


Fig. 1. Reciprocal space mapping around 301 diffraction of RuO₂ thin film epitaxially grown on YSZ (111) surface with self-buffering method.

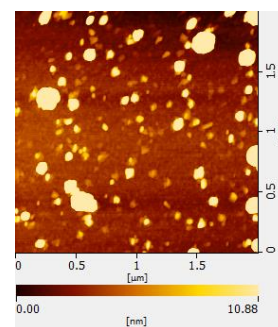


Fig. 2. Surface morphology of rutile RuO₂ epitaxial thin film on YSZ substrate.